

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	BSH205,215
Manufacturer:	NXP USA Inc.
Package:	Please confirm with sales
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/nxp-usa-inc/bsh205-215.html>

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Contact Information

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New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <http://www.nxp.com>, <http://www.philips.com/> or <http://www.semiconductors.philips.com/>, use **<http://www.nexperia.com>**

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If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

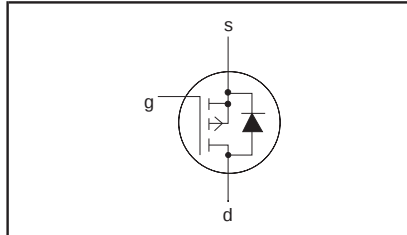
P-channel enhancement mode MOS transistor

BSH205

FEATURES

- Very low threshold voltage
- Fast switching
- Logic level compatible
- Subminiature surface mount package

SYMBOL



QUICK REFERENCE DATA

$$V_{DS} = -12 \text{ V}$$

$$I_D = -0.75 \text{ A}$$

$$R_{DS(ON)} \leq 0.5 \, \Omega \quad (V_{GS} = -2.5 \text{ V})$$

$$V_{GS(TO)} \geq 0.4 \text{ V}$$

GENERAL DESCRIPTION

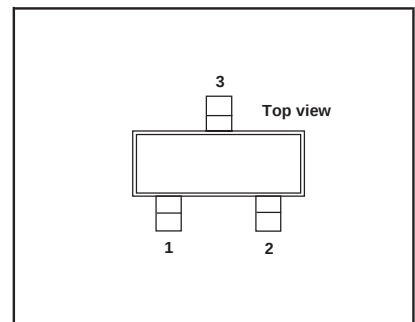
P-channel, enhancement mode, logic level, field-effect power transistor. This device has low threshold voltage and extremely fast switching making it ideal for battery powered applications and high speed digital interfacing.

The BSH205 is supplied in the SOT23 subminiature surface mounting package.

PINNING

PIN	DESCRIPTION
1	gate
2	source
3	drain

SOT23



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	Drain-source voltage		-	-12	V
V_{DGR}	Drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	-12	V
V_{GS}	Gate-source voltage		-	± 8	V
I_D	Drain current (DC)	$T_a = 25 \text{ }^\circ\text{C}$	-	-0.75	A
		$T_a = 100 \text{ }^\circ\text{C}$	-	-0.47	A
I_{DM}	Drain current (pulse peak value)	$T_a = 25 \text{ }^\circ\text{C}$	-	-3	A
P_{tot}	Total power dissipation	$T_a = 25 \text{ }^\circ\text{C}$	-	0.417	W
		$T_a = 100 \text{ }^\circ\text{C}$	-	0.17	W
T_{stg}, T_j	Storage & operating temperature		- 55	150	$^\circ\text{C}$

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-a}$	Thermal resistance junction to ambient	FR4 board, minimum footprint	300	-	K/W

P-channel enhancement mode MOS transistor

BSH205

ELECTRICAL CHARACTERISTICS

 $T_j = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}; I_D = -10\text{ }\mu\text{A}$	-12	-	-	V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = -1\text{ mA}$ $T_j = 150^\circ\text{C}$	-0.4 -0.1	-0.68 -	- -	V V
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = -4.5\text{ V}; I_D = -430\text{ mA}$ $V_{GS} = -2.5\text{ V}; I_D = -430\text{ mA}$ $V_{GS} = -1.8\text{ V}; I_D = -210\text{ mA}$ $V_{GS} = -2.5\text{ V}; I_D = -430\text{ mA}; T_j = 150^\circ\text{C}$	- - - -	0.18 0.32 0.42 0.48	0.4 0.5 0.6 0.75	Ω Ω Ω Ω
g_{fs}	Forward transconductance	$V_{DS} = -9.6\text{ V}; I_D = -430\text{ mA}$	0.5	1.6	-	S
I_{GSS}	Gate source leakage current	$V_{GS} = \pm 8\text{ V}; V_{DS} = 0\text{ V}$	-	± 10	± 100	nA
I_{DSS}	Zero gate voltage drain current	$V_{DS} = -9.6\text{ V}; V_{GS} = 0\text{ V};$ $T_j = 150^\circ\text{C}$	-	-50 -11	-100 -100	nA μA
$Q_{g(tot)}$	Total gate charge	$I_D = -0.5\text{ A}; V_{DD} = -10\text{ V}; V_{GS} = -4.5\text{ V}$	-	3.8	-	nC
Q_{gs}	Gate-source charge		-	0.4	-	nC
Q_{gd}	Gate-drain (Miller) charge		-	1.0	-	nC
$t_{d\ on}$	Turn-on delay time	$V_{DD} = -10\text{ V}; I_D = -0.5\text{ A};$	-	2	-	ns
t_r	Turn-on rise time	$V_{GS} = -8\text{ V}; R_G = 6\text{ }\Omega$	-	4.5	-	ns
$t_{d\ off}$	Turn-off delay time	Resistive load	-	45	-	ns
t_f	Turn-off fall time		-	20	-	ns
C_{iss}	Input capacitance	$V_{GS} = 0\text{ V}; V_{DS} = -9.6\text{ V}; f = 1\text{ MHz}$	-	200	-	pF
C_{oss}	Output capacitance		-	95	-	pF
C_{rss}	Feedback capacitance		-	41	-	pF

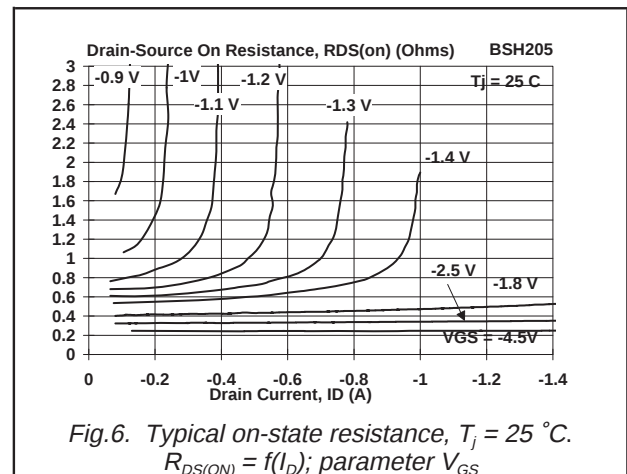
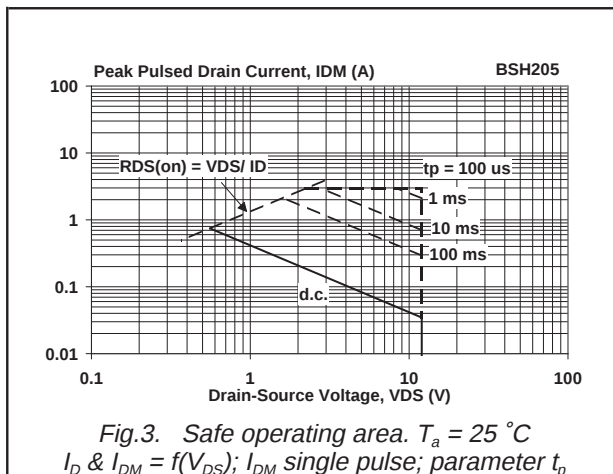
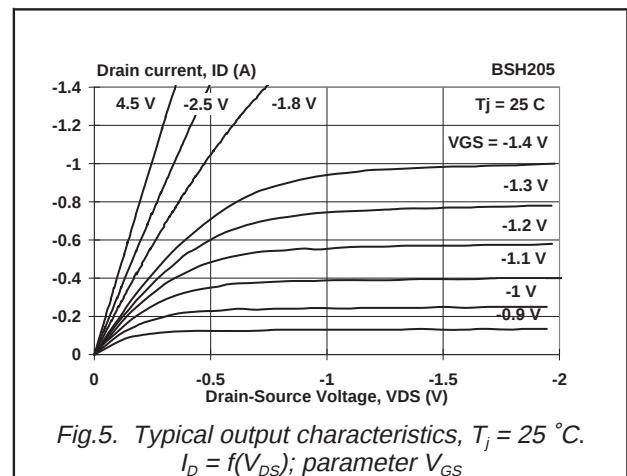
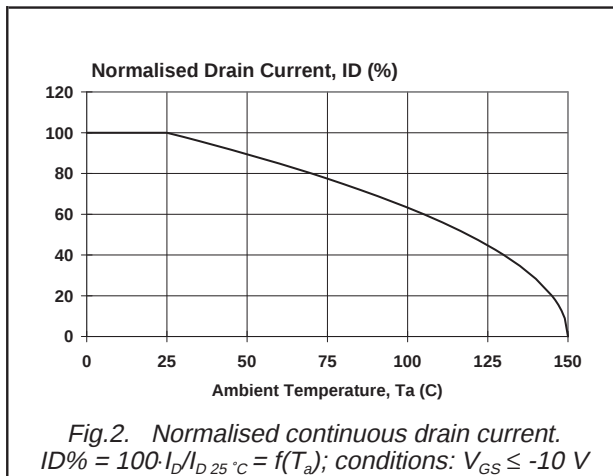
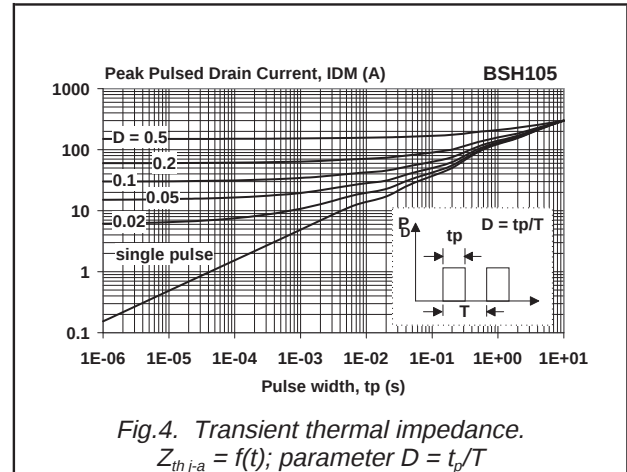
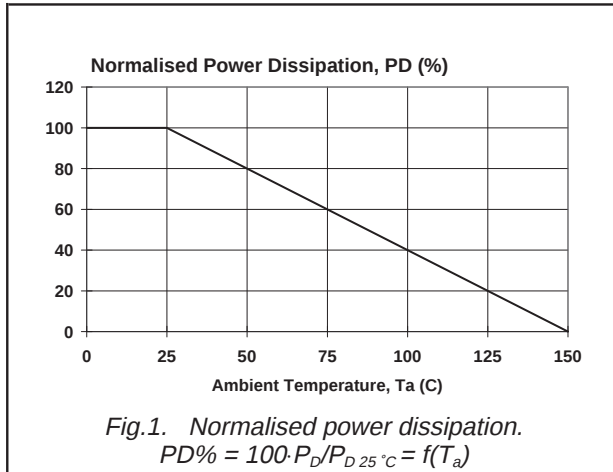
REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

 $T_j = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{DR}	Continuous reverse drain current	$T_a = 25^\circ\text{C}$	-	-	-0.75	A
I_{DRM}	Pulsed reverse drain current		-	-	-3	A
V_{SD}	Diode forward voltage	$I_F = -0.38\text{ A}; V_{GS} = 0\text{ V}$	-	-0.72	-1.3	V
t_{rr}	Reverse recovery time	$I_F = -0.5\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s};$	-	75	-	ns
Q_{rr}	Reverse recovery charge	$V_{GS} = 0\text{ V}; V_R = -9.6\text{ V}$	-	69	-	nC

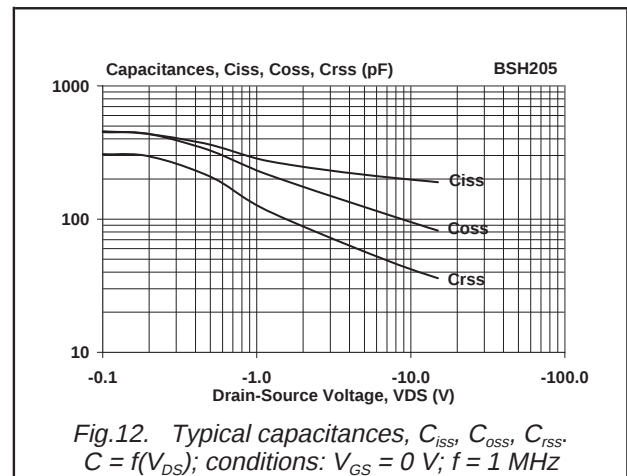
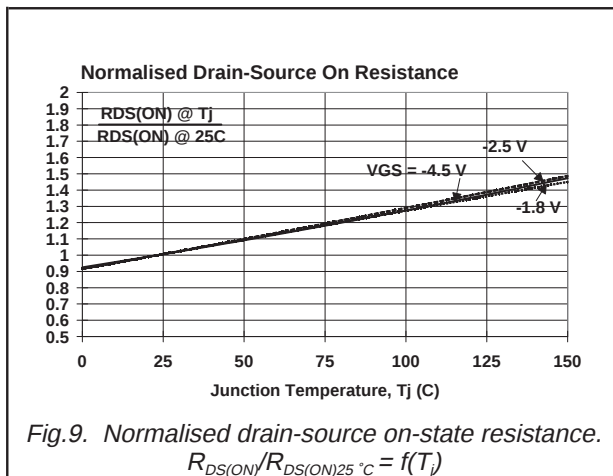
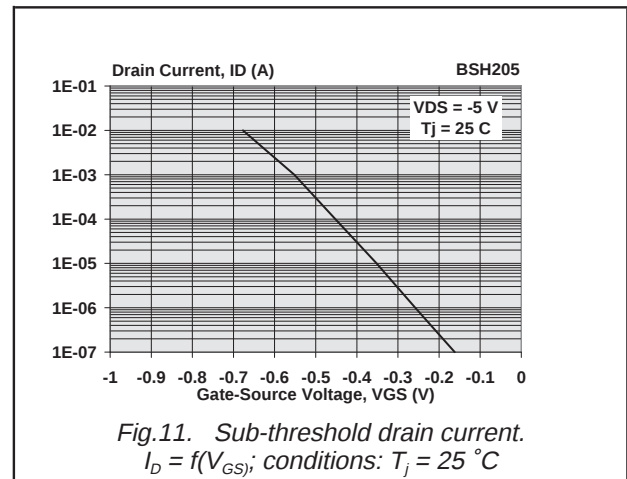
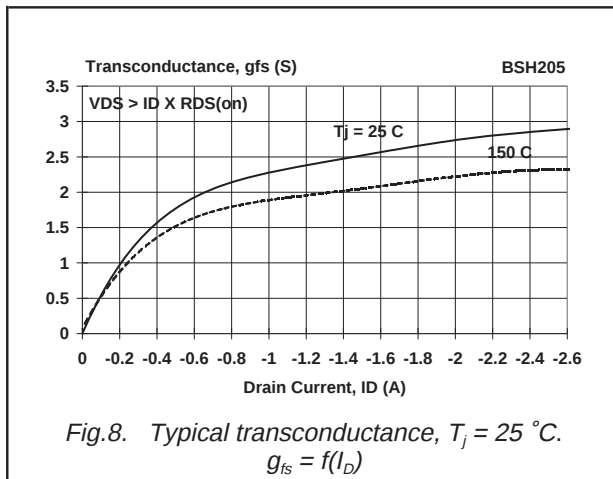
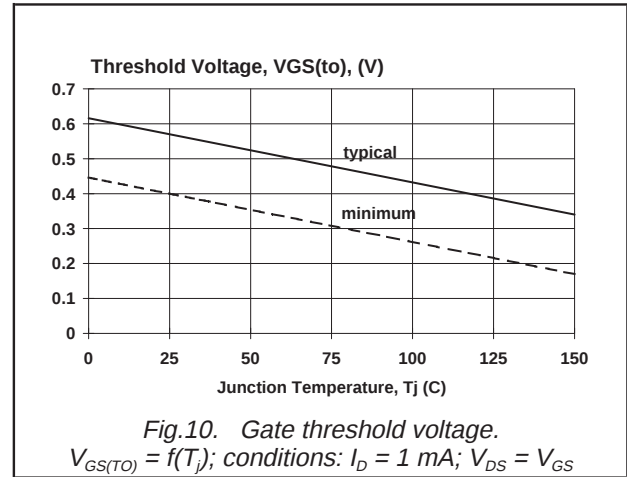
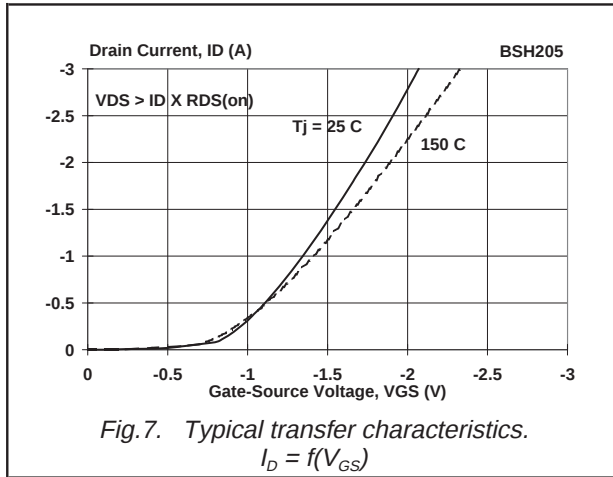
P-channel enhancement mode MOS transistor

BSH205



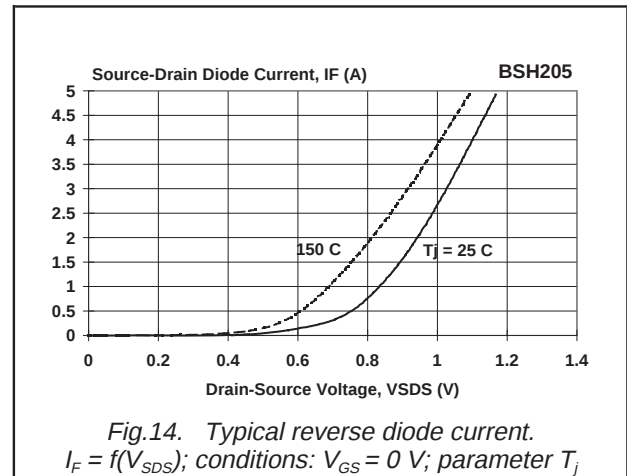
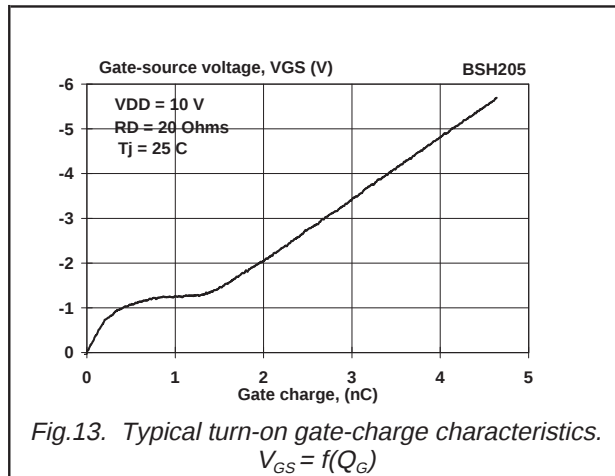
P-channel enhancement mode MOS transistor

BSH205



P-channel enhancement mode MOS transistor

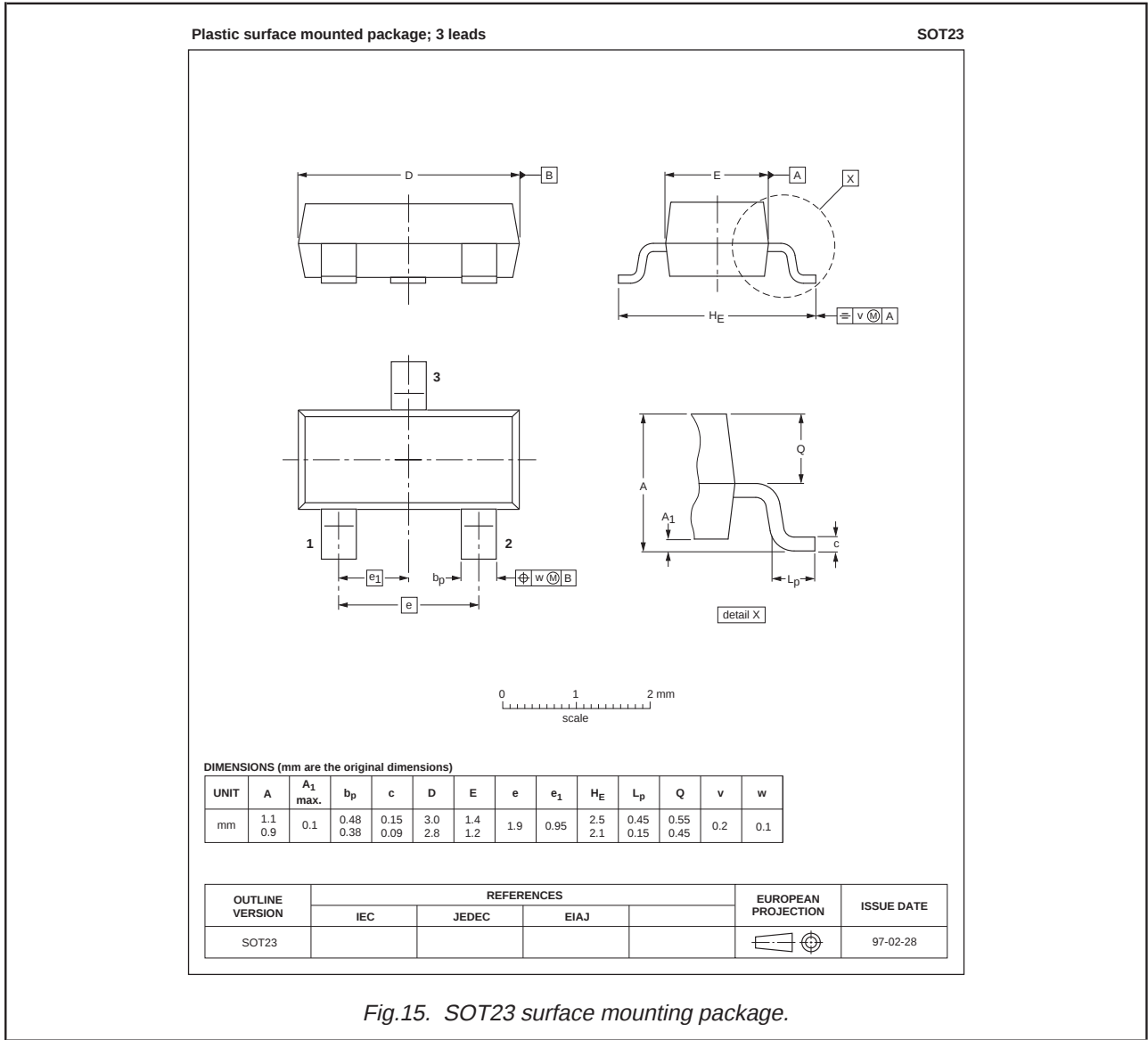
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P-channel enhancement mode
MOS transistor

BSH205

MECHANICAL DATA



Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".